NCE N-Channel Super Trench Power MOSFET

Description

The NCEP40T35AVD uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\rm DS(ON)}$ and $Q_{\rm g}.$ This device is ideal for high-frequency switching and synchronous rectification.

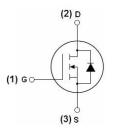
Application

- DC/DC Converter
- •Ideal for high-frequency switching and synchronous rectification

General Features

- V_{DS} =40V, I_D =350A $R_{DS(ON)}$ =0.68m Ω (typical) @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!







Schematic diagram

Marking and pin assignment

TO-263-7L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP40T35AVD	NCEP40T35AVD	TO-263-7L	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	40	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I _D	350	Α
Drain Current-Continuous(T _C =100 °C)	I _D (100°C)	245	А
Pulsed Drain Current	I _{DM}	1400	Α
Maximum Power Dissipation	P _D	380	W
Derating factor		2.53	W/℃
Single pulse avalanche energy (Note 1)	E _{AS}	3000	mJ
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance,Junction-to-Case	Rejc	0.39	°C/W
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NCEP40T35AVD

Electrical Characteristics (T_C=25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	43		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics			•	•		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\mu A$	2.0	3.0	4.0	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =175A	-	0.68	0.88	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =175A	100	-	-	S
Dynamic Characteristics	·					
Input Capacitance	C _{lss}	V _{DS} =20V,V _{GS} =0V,	-	12850	-	PF
Output Capacitance	Coss		-	4641	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	205	-	PF
Switching Characteristics (Note 2)	·					
Turn-on Delay Time	t _{d(on)}		-	26	-	nS
Turn-on Rise Time	tr	V_{DD} =20 V , I_D =175 A	-	14	-	nS
Turn-Off Delay Time	t _{d(off)}	$V_{\text{GS}}\text{=}10V, R_{\text{G}}\text{=}1.6\Omega$	-	110	-	nS
Turn-Off Fall Time	t _f		-	17	-	nS
Total Gate Charge	Qg	\/ 00\/ L 475A	-	156.5	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =20V, I_D =175A, V_{GS} =10V	-	59		nC
Gate-Drain Charge	Q_{gd}		-	23.5		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =175A	-		1.2	V
Diode Forward Current	Is		-	-	350	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = I _S	-	66	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/μs	-	240	-	nC

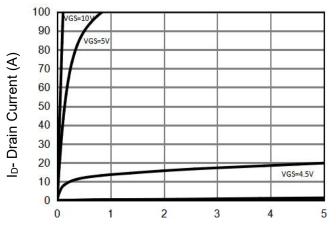
Notes:

^{1.} EAS condition : Tj=25 $^{\circ}\text{C}$,VDD=20V,VG=10V,L=0.5mH,Rg=25 Ω

^{2.} Guaranteed by design, not subject to production

^{3.} These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsin k, assuming a maximum junction temperature of TJ(MAX)=175° C. The SOA curve provides a single pulse rating.

Typical Electrical and Thermal Characteristics



Vds Drain-Source Voltage (V)



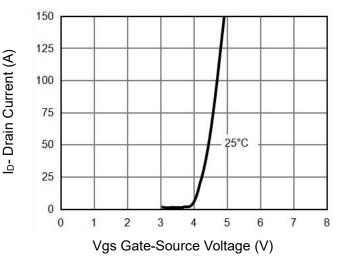


Figure 2 Transfer Characteristics

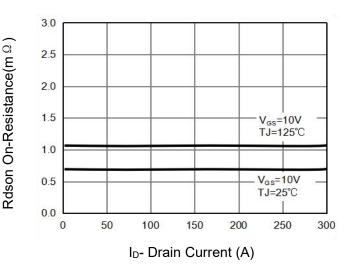


Figure 3 Rdson- Drain Current

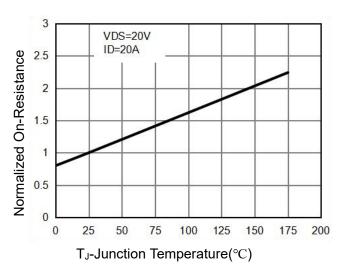


Figure 4 Rdson-Junction Temperature

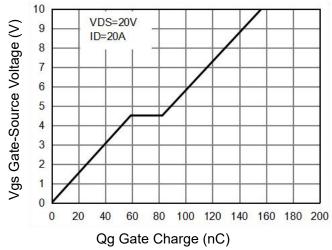


Figure 5 Gate Charge

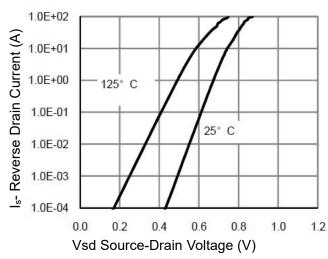
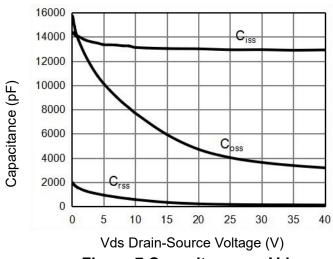


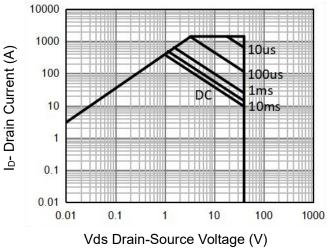
Figure 6 Source- Drain Diode Forward



500 400 Power Dissipation (W) 300 200 100 0 0 25 50 75 100 125 150 175 T_A-Case Temperature(°C)

Figure 7 Capacitance vs Vds

Figure 9 Power De-rating



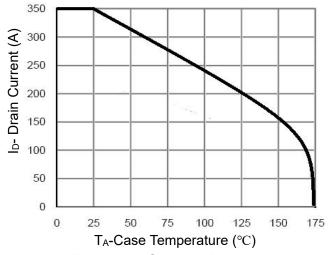


Figure 8 Safe Operation Area(Note 3)

Figure 10 Current De-rating

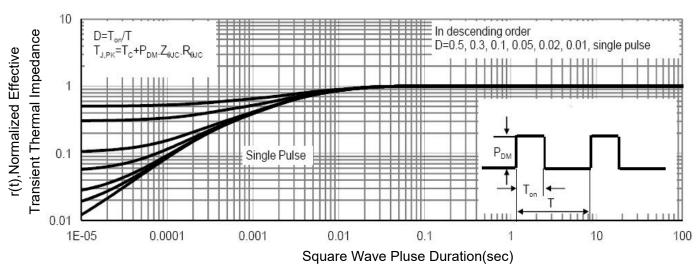
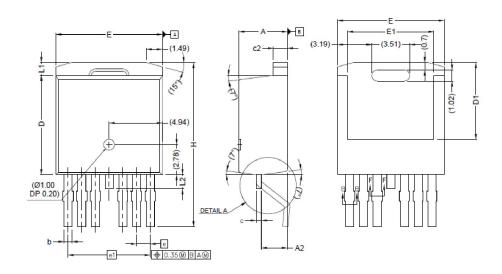
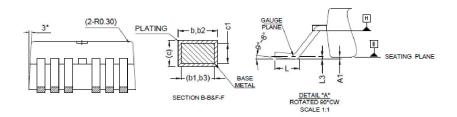


Figure 11 Normalized Maximum Transient Thermal Impedance

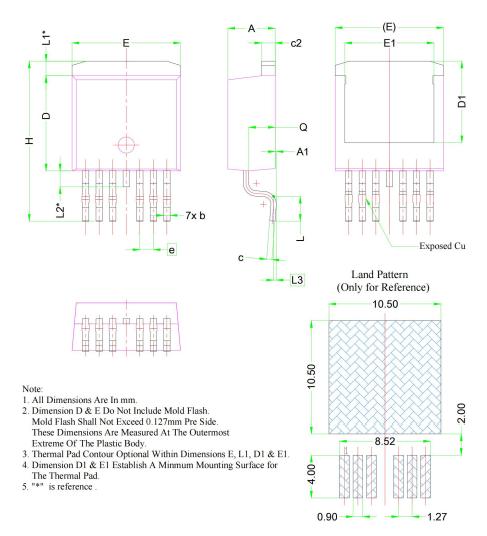
TO-263-7L (B) Package Information





SYMBOL	MIN	MAX	
Α	4.30	4.70	
A1	-	0.25	
A2	2.20	2.60	
b	0.65	0.85	
b1	0.65	0.80	
b2	0.80	1.00	
b3	0.80	0.95	
C	0.45	0.60	
c1	0.45	0.55	
c2	1.25	1.40	
D	9.00	9.40	
D1	6.86	7.42	
E	9.68	10.08	
E1	7.70	8.30	
е	1.27	7 BSC	
e1	7.62	2 BSC	
L	1.78	2.79	
L1	-	1.60	
L2	=	1.78	
L3	0.25BSC		
Н	14.61	15.88	

TO-263-7L (G) Package Information



SYMBOL	DIMENSIONS				
	MIN.	NOM.	MAX.		
Α	4.24	4.44	4.64		
A1	0.00	0.10	0.25		
b	0.50	0.60	0.70		
С	0.40	0.50	0.60		
c2	1.15	1.27	1.40		
D	8.82	8.92	9.02		
D1	6.86	7.65			
E	9.96	10.16	10.36		
E1	8.20	8.35	8.50		
е					
Н	14.61	15.00	15.88		
L	1.78 2.32		2.79		
L1	1.36 REF.				
L2	1.50 REF.				
L3	0.25 BSC				
Q	2.30	2.48	2.70		

NCEP40T35AVD

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